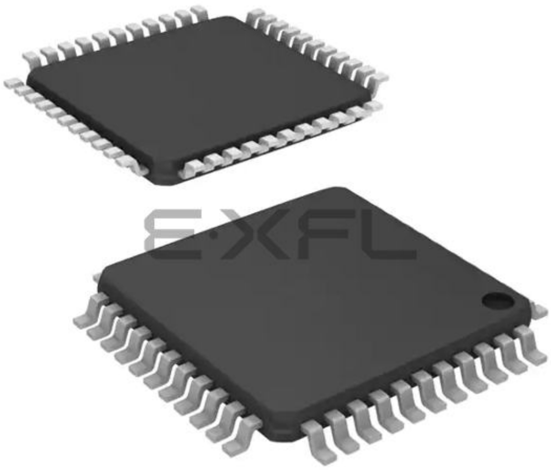

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f15376-i-pt

TABLE 1-4: PIC16(L)F15385/86 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RF5/ANF5	RF5	TTL/ST	CMOS/OD	General purpose I/O.
	ANF5	AN	—	ADC Channel D0 input.
RF6/ANF6	RF6	TTL/ST	CMOS/OD	General purpose I/O.
	ANF6	AN	—	ADC Channel D0 input.
RF7/ANF7	RF5	TTL/ST	CMOS/OD	General purpose I/O.
	ANF5	AN	—	ADC Channel D0 input.
V_{DD}	V_{DD}	Power	—	Positive supply voltage input.
V_{SS}	V_{SS}	Power	—	Ground reference.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open-Drain; TTL = TTL compatible input; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C; HV = High Voltage; XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 15-4 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 15-5, Table 15-6 and Table 15-7.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

TABLE 4-7: PIC16(L)F15356/75/76/85/86 MEMORY MAP, BANK 24-31

	BANK 24	BANK 25	BANK 26	BANK 27	BANK 28	BANK 29	BANK 30	BANK 31
Address	C00h	C80h	D00h	D80h	E00h	E80h	F00h	F80h
	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)	Core Registers (Table 4-3)
Address	C0Bh	C8Bh	D0Bh	D8Bh	E0Bh	E8Bh	F0Bh	F8Bh
Address	C0Ch	C8Ch	D0Ch					
	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’	Unimplemented Read as ‘0’
Address	C1Fh	C9Fh						
Address	C20h	CA0h						
	General Purpose Register 80 Bytes(1)	General Purpose Register 80 Bytes(1)						
Address	C6Fh	CEFh	D6Fh	DEFh	E6Fh	EEFh	F6Fh	FEFh
Address	C70h	CF0h	D70h	DF0h	E70h	EF0h	F70h	FF0h
	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh	Accesses 70h – 7Fh
Address	CFFh	CFFh	D7Fh	DFFh	E7Fh	EFFh	F7Fh	FFFh

Legend: (shaded) = Unimplemented data memory locations, read as ‘0’.

Note 1: Present only in PIC16(L)F15356/76/86.

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 15											
CPU CORE REGISTERS; see Table 4-3 for specifics											
78Ch — 795h	—	Unimplemented								—	—
796h	PMD0	SYSCMD	FVRMD	—	—	—	NVMMD	CLKRMD	IOCMD	00-- -000	00-- -000
797h	PMD1	NCO1MD	—	—	—	—	TMR2MD	TMR1MD	TMR0MD	0--- -000	0--- -000
798h	PMD2	—	DAC1MD	ADCMD	—	—	CMP2MD	CMP1MD	ZCDMD	-00- -000	-00- -000
799h	PMD3	—	—	PWM6MD	PWM5MD	PWM4MD	PWM3MD	CCP2MD	CCP1MD	--00 0000	--00 0000
79Ah	PMD4	UART2MD	UART1MD	MSSP2MD	MSSP1MD	—	—	—	CWG1MD	0000 ---0	0000 ---0
79Bh	PMD5	—	—	—	CLC4MD	CLC3MD	CLC2MD	CLC1MD	—	---0 000-	---0 000-
79Ch	—	Unimplemented								—	—
79Dh	—	Unimplemented								—	—
79Eh	—	Unimplemented								—	—
79Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Preliminary

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 62 (Continued)											
1F38h	ANSELA	ANSA7	ANSA6	ANSA5	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	1111 1111	1111 1111
1F39h	WPUA	WPUA7	WPUA6	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	0000 0000	0000 0000
1F3Ah	ODCONA	ODCA7	ODCA6	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	0000 0000	0000 0000
1F3Bh	SLRCONA	SLRA7	SLRA6	SLRA5	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0	1111 1111	1111 1111
1F3Ch	INLVLA	INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0	1111 1111	1111 1111
1F3Dh	IOCAP	IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	0000 0000	0000 0000
1F3Eh	IOCAN	IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	0000 0000	0000 0000
1F3Fh	IOCAF	IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	0000 0000	0000 0000
1F40h	—	Unimplemented								—	—
1F41h	—	Unimplemented								—	—
1F42h	—	Unimplemented								—	—
1F43h	ANSELB	ANSB7	ANSB6	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	1111 1111	1111 1111
1F44h	WPUB	WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0	0000 0000	0000 0000
1F45h	ODCONB	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0	0000 0000	0000 0000
1F46h	SLRCONB	SLRB7	SLRB6	SLRB5	SLRB4	SLRB3	SLRB2	SLRB1	SLRB0	1111 1111	1111 1111
1F47h	INLVLB	INLVLB7	INLVLB6	INLVLB5	INLVLB4	INLVLB3	INLVLB2	INLVLB1	INLVLB0	1111 1111	1111 1111
1F48h	IOCBP	IOCBP7	IOCBP6	IOCBP5	IOCBP4	IOCBP3	IOCBP2	IOCBP1	IOCBP0	0000 0000	0000 0000
1F49h	IOCBN	IOCBN7	IOCBN6	IOCBN5	IOCBN4	IOCBN3	IOCBN2	IOCBN1	IOCBN0	0000 0000	0000 0000
1F4Ah	IOCBF	IOCBF7	IOCBF6	IOCBF5	IOCBF4	IOCBF3	IOCBF2	IOCBF1	IOCBF0	0000 0000	0000 0000
1F4Bh	—	Unimplemented								—	—
1F4Ch	—	Unimplemented								—	—
1F4Dh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Preliminary

4.5 Stack

All devices have a 16-level x 15-bit wide hardware stack (refer to Figure 4-5 through Figure 4-8). The stack space is not part of either program or data space. The PC is PUSHed onto the stack when `CALL` or `CALLW` instructions are executed or an interrupt causes a branch. The stack is POPed in the event of a `RETURN`, `RETLW` or a `RETFIE` instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer if the STVREN bit is programmed to '0' (Configuration Words). This means that after the stack has been PUSHed sixteen times, the seventeenth PUSH overwrites the value that was stored from the first PUSH. The eighteenth PUSH overwrites the second PUSH (and so on). The STKOVF and STKUNF flag bits will be set on an Overflow/Underflow, regardless of whether the Reset is enabled.

Note 1:	There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the `CALL`, `CALLW`, `RETURN`, `RETLW` and `RETFIE` instructions or the vectoring to an interrupt address.

4.5.1 ACCESSING THE STACK

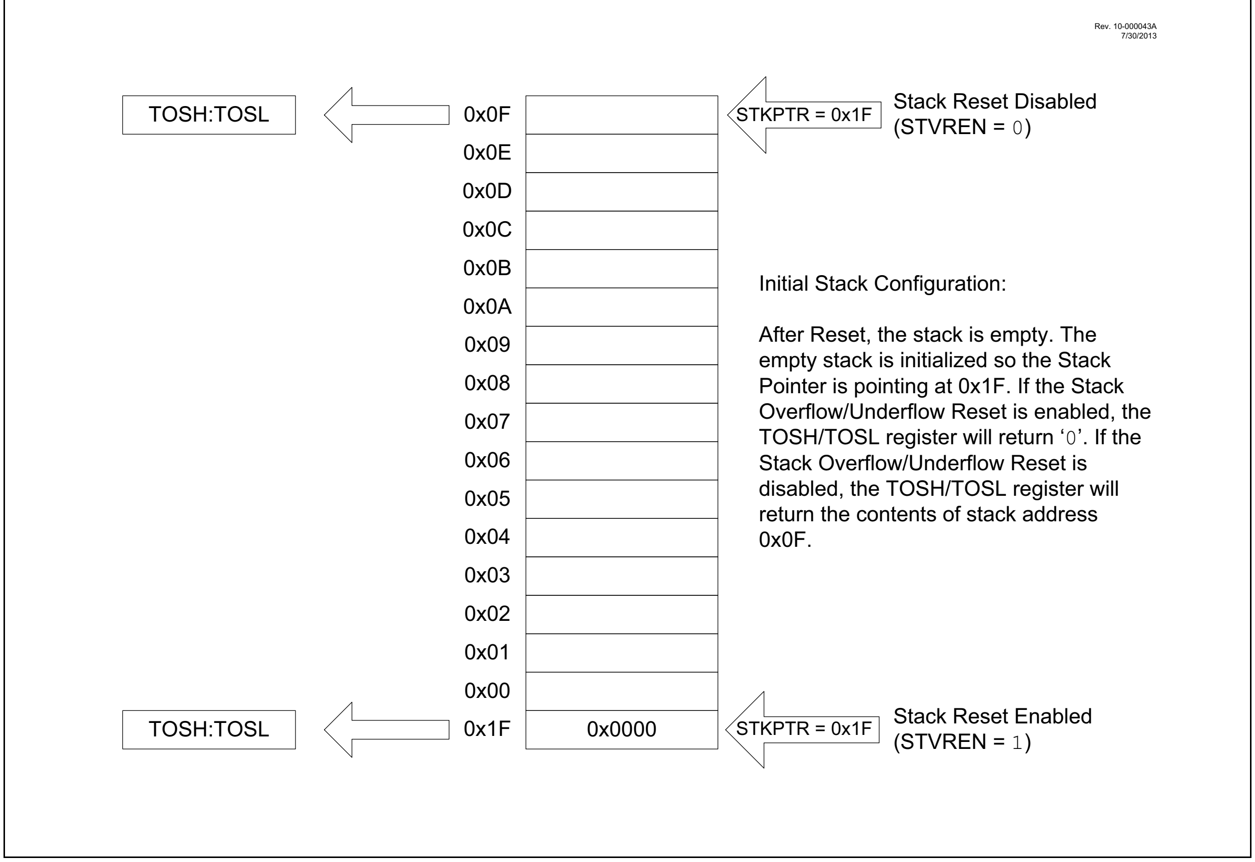
The stack is accessible through the TOSH, TOSL and STKPTR registers. STKPTR is the current value of the Stack Pointer. TOSH:TOSL register pair points to the TOP of the stack. Both registers are read/writable. TOS is split into TOSH and TOSL due to the 15-bit size of the PC. To access the stack, adjust the value of STKPTR, which will position TOSH:TOSL, then read/write to TOSH:TOSL. STKPTR is five bits to allow detection of overflow and underflow.

Note:	Care should be taken when modifying the STKPTR while interrupts are enabled.

During normal program operation, `CALL`, `CALLW` and interrupts will increment STKPTR while `RETLW`, `RETURN`, and `RETFIE` will decrement STKPTR. STKPTR can be monitored to obtain to value of stack memory left at any given time. The STKPTR always points at the currently used place on the stack. Therefore, a `CALL` or `CALLW` will increment the STKPTR and then write the PC, and a return will unload the PC value from the stack and then decrement the STKPTR.

Reference Figure 4-5 through Figure 4-8 for examples of accessing the stack.

FIGURE 4-5: ACCESSING THE STACK EXAMPLE 1



8.2.3 BOR CONTROLLED BY SOFTWARE

When the BOREN bits of Configuration Words are programmed to '01', the BOR is controlled by the SBOREN bit of the BORCON register. The device start-up is not delayed by the BOR ready condition or the VDD level.

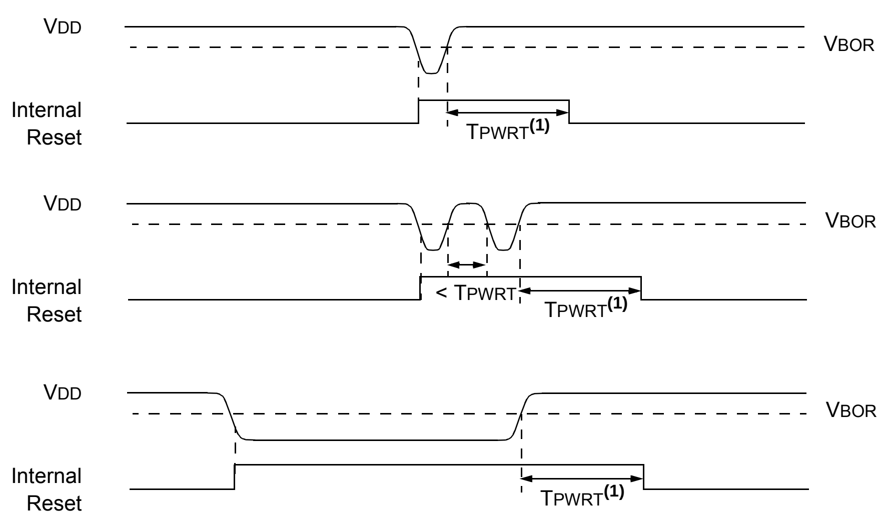
BOR protection begins as soon as the BOR circuit is ready. The status of the BOR circuit is reflected in the BORRDY bit of the BORCON register.

BOR protection is unchanged by Sleep.

8.2.4 BOR IS ALWAYS OFF

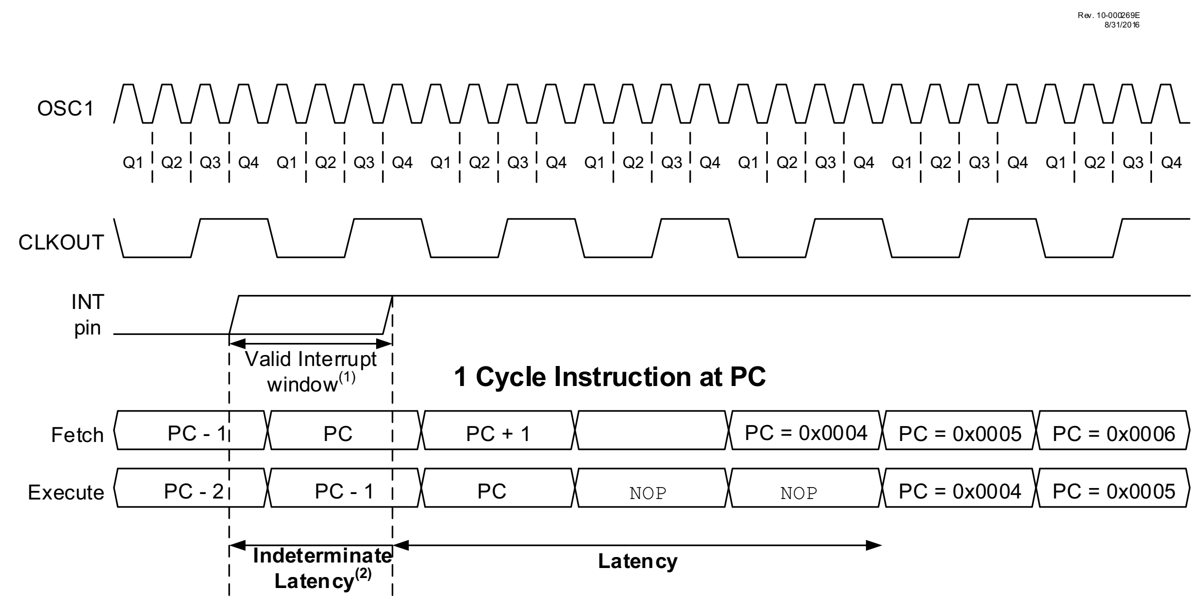
When the BOREN bits of the Configuration Words are programmed to '00', the BOR is off at all times. The device start-up is not delayed by the BOR ready condition or the VDD level.

FIGURE 8-2: BROWN-OUT SITUATIONS



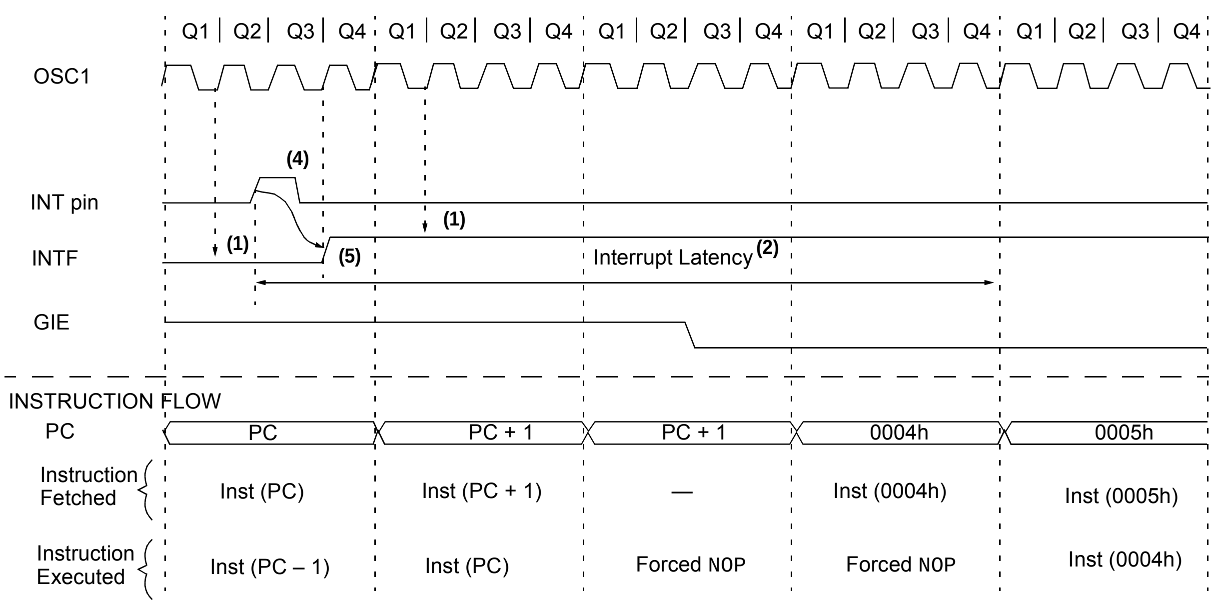
Note 1: TPWRT delay only if $\overline{\text{PWRTE}}$ bit is programmed to '0'.

FIGURE 10-2: INTERRUPT LATENCY



Note 1: An interrupt may occur at any time during the interrupt window.
2: Since an interrupt may occur any time during the interrupt window, the actual latency can vary.

FIGURE 10-3: INT PIN INTERRUPT TIMING



Note 1: INTF flag is sampled here (every Q1).

2: Asynchronous interrupt latency = 3-5 TCY. Synchronous latency = 3-4 TCY, where TCY = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.

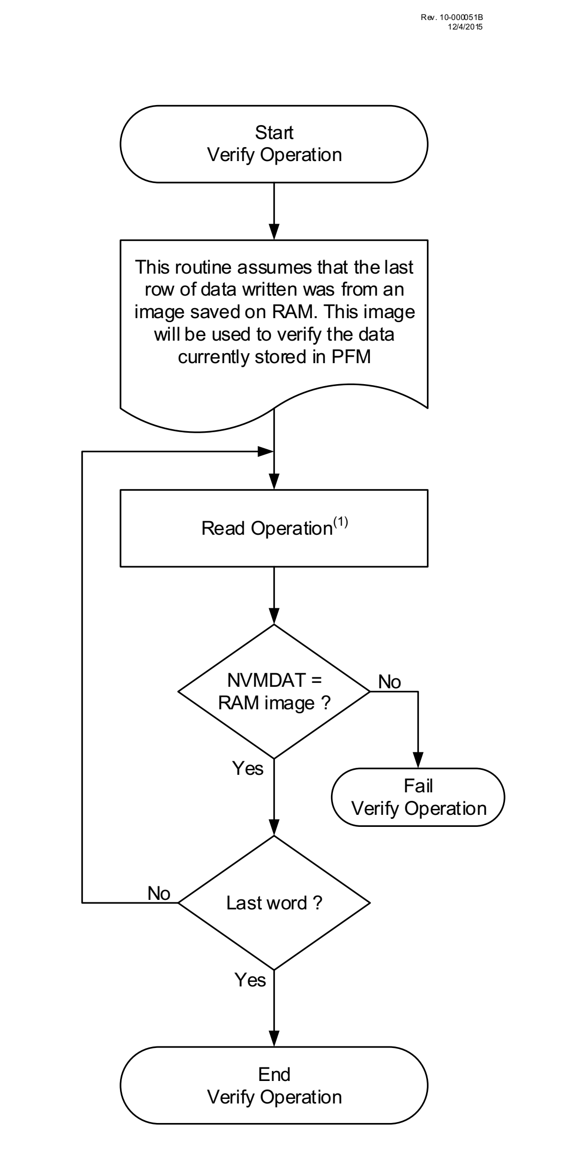
3: For minimum width of INT pulse, refer to AC specifications in **Section 37.0 "Electrical Specifications"**.

4: INTF may be set any time during the Q4-Q1 cycles.

13.3.7 WRITE VERIFY

It is considered good programming practice to verify that program memory writes agree with the intended value. Since program memory is stored as a full row then the stored program memory contents are compared with the intended data stored in RAM after the last write is complete.

FIGURE 13-7: FLASH PROGRAM MEMORY VERIFY FLOWCHART



Note 1: See Figure 13-1.

13.3.8 WRERR BIT

The WRERR bit can be used to determine if a write error occurred.

WRERR will be set if one of the following conditions occurs:

- If WR is set while the NVMADRH:NMVADRL points to a write-protected address
- A Reset occurs while a self-write operation was in progress
- An unlock sequence was interrupted

The WRERR bit is normally set by hardware, but can be set by the user for test purposes. Once set, WRERR must be cleared in software.

TABLE 13-4: ACTIONS FOR PFM WHEN WR = 1

Free	LWLO	Actions for PFM when WR = 1	Comments
1	x	Erase the 32-word row of NVMADRH:NVMADRL location. See **Section 13.3.3 “NVMREG Erase of PFM”**	• If WP is enabled, WR is cleared and WRERR is set • All 32 words are erased • NVMDATH:NVMDATL is ignored
0	1	Copy NVMDATH:NVMDATL to the write latch corresponding to NVMADR LSBs. See **Section 13.3.3 “NVMREG Erase of PFM”**	• Write protection is ignored • No memory access occurs
0	0	Write the write-latch data to PFM row. See **Section 13.3.3 “NVMREG Erase of PFM”**	• If WP is enabled, WR is cleared and WRERR is set • Write latches are reset to 3FFh • NVMDATH:NVMDATL is ignored

REGISTER 15-2: RxyPPS: PIN Rxy OUTPUT SOURCE SELECTION REGISTER

U-0	U-0	U-0	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u
—	—	—	RxyPPS<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **RxyPPS<4:0>:** Pin Rxy Output Source Selection bits
See Table 15-5 through Table 15-7.

Note 1: TRIS control is overridden by the peripheral as required.

REGISTER 15-3: PPSLOCK: PPS LOCK REGISTER

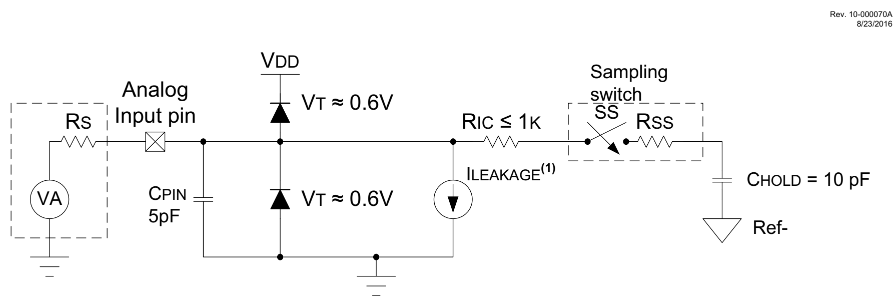
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0
—	—	—	—	—	—	—	PPSLOCKED
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

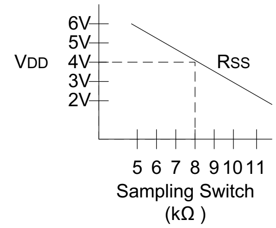
bit 7-1 **Unimplemented:** Read as ‘0’

bit 0 **PPSLOCKED:** PPS Locked bit
1= PPS is locked. PPS selections can not be changed.
0= PPS is not locked. PPS selections can be changed.

FIGURE 20-4: ANALOG INPUT MODEL



Legend:
CHOLD = Sample/Hold Capacitance
CPIN = Input Capacitance
ILEAKAGE = Leakage Current at the pin due to varies injunctions
RIC = Interconnect Resistance
RSS = Resistance of Sampling switch
SS = Sampling Switch
VT = Threshold Voltage
RS = Source Resistance



Note 1: See Refer to **Section 37.0 "Electrical Specifications"**.

FIGURE 20-5: ADC TRANSFER FUNCTION

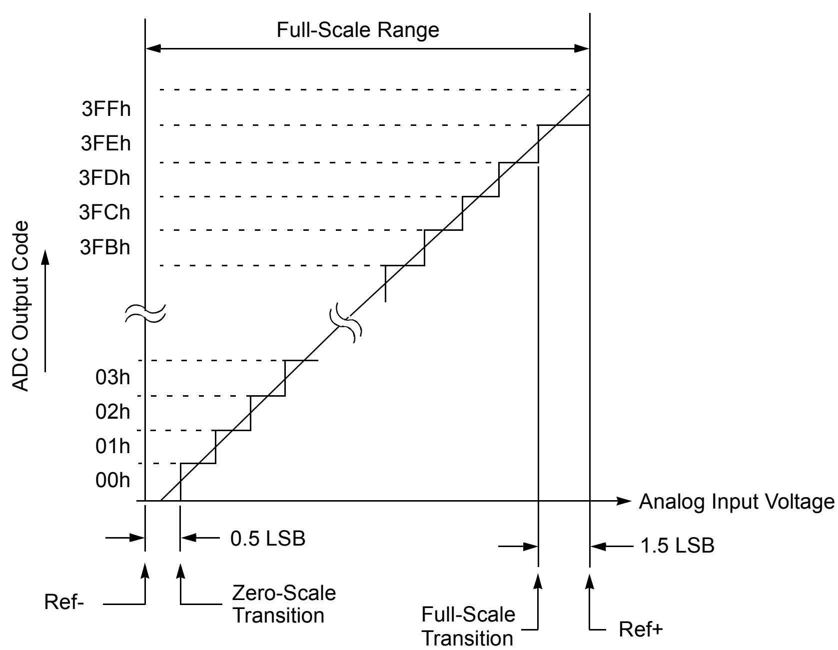
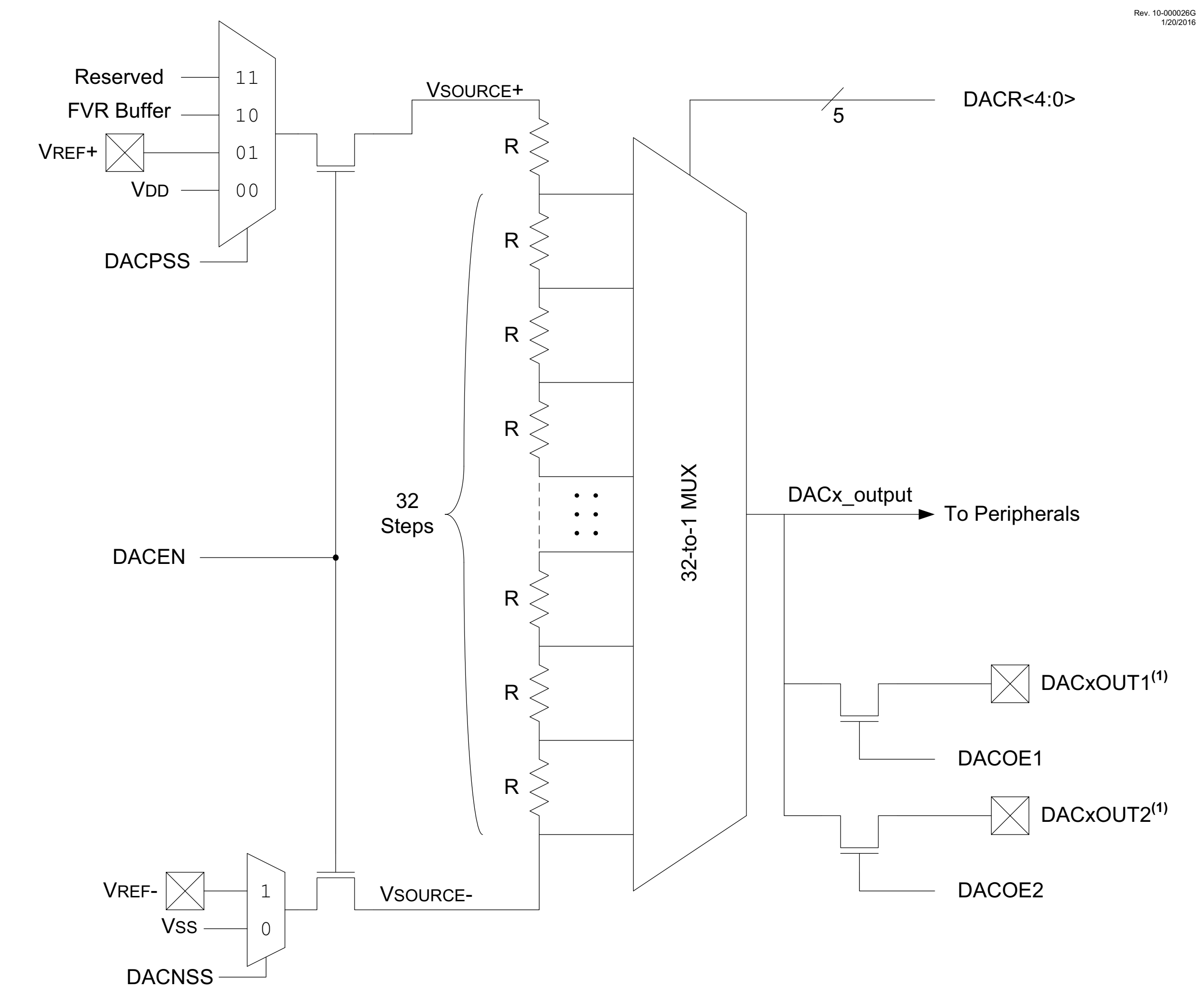
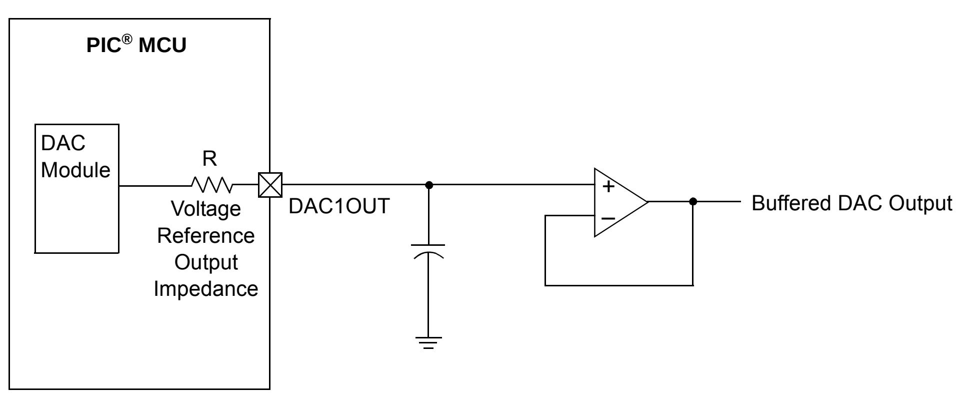


FIGURE 21-1: DIGITAL-TO-ANALOG CONVERTER BLOCK DIAGRAM



Note 1: The unbuffered DACx_output is provided on the DA

FIGURE 21-2: VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE



26.6.2 TIMER GATE SOURCE SELECTION

One of the several different external or internal signal sources may be chosen to gate the timer and allow the timer to increment. The gate input signal source can be selected based on the T1GATE register setting. See the T1GATE register (Register 26-4) description for a complete list of the available gate sources. The polarity for each available source is also selectable. Polarity selection is controlled by the GPOL bit of the T1GCON register.

26.6.2.1 T1G Pin Gate Operation

The T1G pin is one source for the timer gate control. It can be used to supply an external source to the time gate circuitry.

26.6.2.2 Timer0 Overflow Gate Operation

When Timer0 overflows, or a period register match condition occurs (in 8-bit mode), a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

26.6.2.3 Comparator C1 Gate Operation

The output resulting from a Comparator 1 operation can be selected as a source for the timer gate control. The Comparator 1 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 23.4.1 "Comparator Output Synchronization"**.

26.6.2.4 Comparator C2 Gate Operation

The output resulting from a Comparator 2 operation can be selected as a source for the timer gate control. The Comparator 2 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 23.4.1 "Comparator Output Synchronization"**.

26.6.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a timer gate signal, as opposed to the duration of a single level pulse.

The timer gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 26-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the GTM bit of the T1GCON register. When the GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

Note:	Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

26.6.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single-pulse gate event. Timer1 Gate Single-Pulse mode is first enabled by setting the GSPM bit in the T1GCON register. Next, the GGO/$\overline{\text{DONE}}$ bit in the T1GCON register must be set. The timer will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the GGO/$\overline{\text{DONE}}$ bit will automatically be cleared. No other gate events will be allowed to increment the timer until the GGO/$\overline{\text{DONE}}$ bit is once again set in software. See Figure 26-5 for timing details.

If the Single-Pulse Gate mode is disabled by clearing the GSPM bit in the T1GCON register, the GGO/$\overline{\text{DONE}}$ bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the timer gate source to be measured. See Figure 26-6 for timing details.

26.6.5 TIMER1 GATE VALUE STATUS

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the GVAL bit in the T1GCON register. The GVAL bit is valid even when the timer gate is not enabled (GE bit is cleared).

26.6.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of GVAL occurs, the TMR1GIF flag bit in the PIR5 register will be set. If the TMR1GIE bit in the PIE5 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the timer gate is not enabled (TMR1GE bit is cleared).

FIGURE 30-6: DEAD-BAND OPERATION CWG1DBR = 0X01, CWG1DBF = 0X02

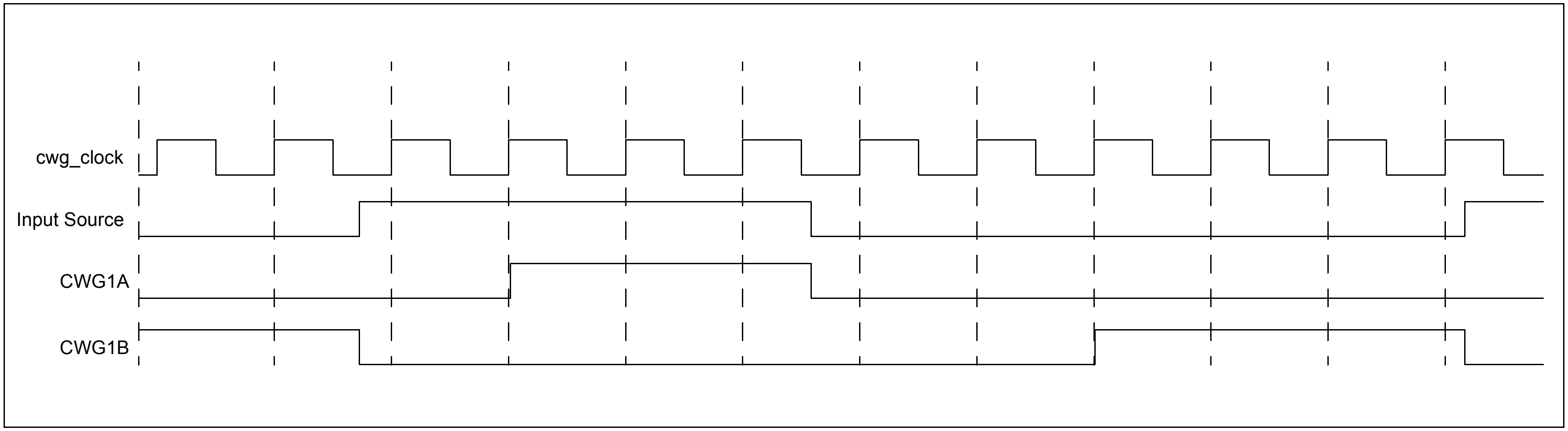
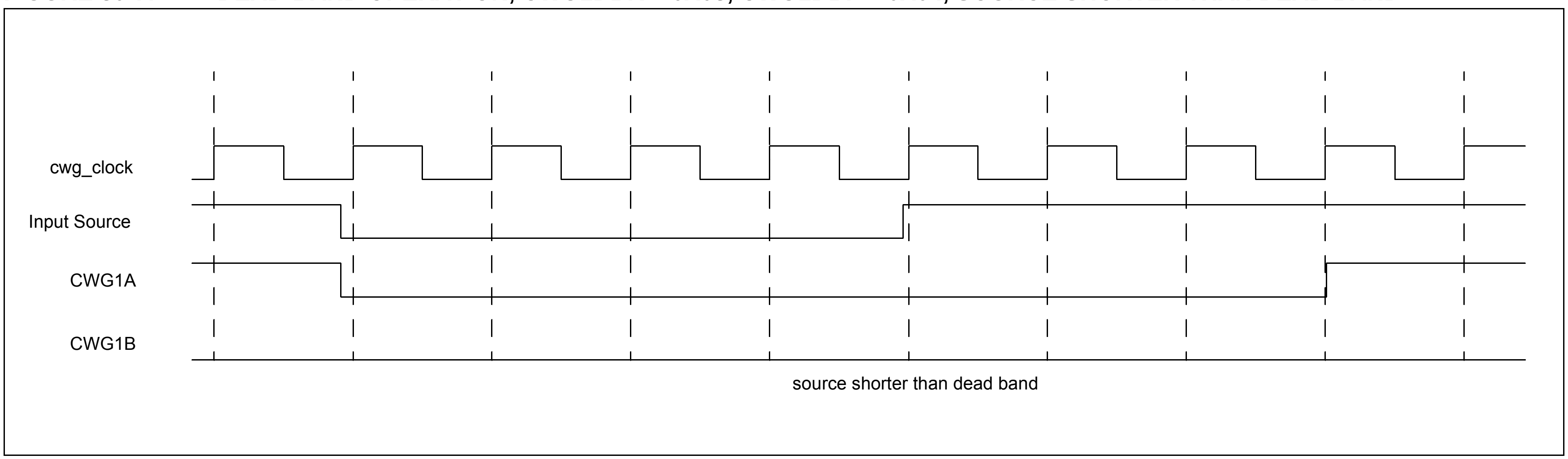


FIGURE 30-7: DEAD-BAND OPERATION, CWG1DBR = 0X03, CWG1DBF = 0X04, SOURCE SHORTER THAN DEAD BAND



30.12 Configuring the CWG

The following steps illustrate how to properly configure the CWG.

1. Ensure that the TRIS control bits corresponding to the desired CWG pins for your application are set so that the pins are configured as inputs.
2. Clear the EN bit, if not already cleared.
3. Set desired mode of operation with the MODE bits.
4. Set desired dead-band times, if applicable to mode, with the CWG1DBR and CWG1DBF registers.
5. Setup the following controls in the CWG1AS0 and CWG1AS1 registers.
   a. Select the desired shutdown source.
   b. Select both output overrides to the desired levels (this is necessary even if not using auto-shutdown because start-up will be from a shut-down state).
   c. Set which pins will be affected by auto-shut-down with the CWG1AS1 register.
   d. Set the SHUTDOWN bit and clear the REN bit.
6. Select the desired input source using the CWG1ISM register.
7. Configure the following controls.
   a. Select desired clock source using the CWG1CLKCON register.
   b. Select the desired output polarities using the CWG1CON1 register.
   c. Set the output enables for the desired outputs.
8. Set the EN bit.
9. Clear TRIS control bits corresponding to the desired output pins to configure these pins as outputs.
10. If auto-restart is to be used, set the REN bit and the SHUTDOWN bit will be cleared automatically. Otherwise, clear the SHUTDOWN bit to start the CWG.

30.12.1 PIN OVERRIDE LEVELS

The levels driven to the output pins, while the shutdown input is true, are controlled by the LSBD and LSAC bits of the CWG1AS0 register. LSBD<1:0> controls the CWG1B and D override levels and LSAC<1:0> controls the CWG1A and C override levels. The control bit logic level corresponds to the output logic drive level while in the shutdown state. The polarity control does not affect the override level.

30.12.2 AUTO-SHUTDOWN RESTART

After an auto-shutdown event has occurred, there are two ways to resume operation:

- Software controlled
- Auto-restart

The restart method is selected with the REN bit of the CWG1CON2 register. Waveforms of software controlled and automatic restarts are shown in Figure 30-13 and Figure 30-14.

30.12.2.1 Software Controlled Restart

When the REN bit of the CWG1AS0 register is cleared, the CWG must be restarted after an auto-shutdown event by software. Clearing the shutdown state requires all selected shutdown inputs to be low, otherwise the SHUTDOWN bit will remain set. The overrides will remain in effect until the first rising edge event after the SHUTDOWN bit is cleared. The CWG will then resume operation.

30.12.2.2 Auto-Restart

When the REN bit of the CWG1CON2 register is set, the CWG will restart from the auto-shutdown state automatically. The SHUTDOWN bit will clear automatically when all shutdown sources go low. The overrides will remain in effect until the first rising edge event after the SHUTDOWN bit is cleared. The CWG will then resume operation.

REGISTER 33-3: BAUDxCON: BAUD RATE CONTROL REGISTER

R/W-0/0	R-1/1	U-0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0
ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **ABDOVF:** Auto-Baud Detect Overflow bit
Asynchronous mode:
1 = Auto-baud timer overflowed
0 = Auto-baud timer did not overflow
Synchronous mode:
Don’t care

bit 6 **RCIDL**: Receive Idle Flag bit
Asynchronous mode:
1 = Receiver is Idle
0 = Start bit has been received and the receiver is receiving
Synchronous mode:
Don’t care

bit 5 **Unimplemented:** Read as ‘0’

bit 4 **SCKP**: Clock/Transmit Polarity Select bit
Asynchronous mode:
1 = Idle state for transmit (TX) is a low level
0 = Idle state for transmit (TX) is a high level
Synchronous mode:
1 = Idle state for clock (CK) is a high level
0 = Idle state for clock (CK) is a low level

bit 3 **BRG16:** 16-bit Baud Rate Generator bit
1 = 16-bit Baud Rate Generator is used
0 = 8-bit Baud Rate Generator is used

bit 2 **Unimplemented:** Read as ‘0’

bit 1 **WUE:** Wake-up Enable bit
Asynchronous mode:
1 = USART will continue to sample the Rx pin – interrupt generated on falling edge; bit cleared in hardware on following rising edge.
0 = RX pin not monitored nor rising edge detected
Synchronous mode:
Unused in this mode – value ignored

bit 0 **ABDEN**: Auto-Baud Detect Enable bit
Asynchronous mode:
1 = Enable baud rate measurement on the next character – requires reception of a SYNCH field (55h);
cleared in hardware upon completion
0 = Baud rate measurement disabled or completed
Synchronous mode:
Unused in this mode – value ignored

REGISTER 34-2: CLKRCLK: CLOCK REFERENCE CLOCK SELECTION REGISTER

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	CLKRCLK<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **CLKRCLK<3:0>:** CLKR Input bits

Clock Selection
1111 = Reserved
•
•
•
1011 = Reserved
1010 = LC4_out
1001 = LC3_out
1000 = LC2_out
0111 = LC1_out
0110 = NCO1_out
0101 = SOSC
0100 = MFINTOSC (31.25 kHz)
0011 = MFINTOSC (500 kHz)
0010 = LFINTOSC
0001 = HFINTOSC
0000 = FOSC

TABLE 34-1: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK REFERENCE OUTPUT

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CLKRCON	CLKREN	—	—	CLKRDC<1:0>		CLKRDIV<2:0>			501
CLKRCLK	—	—	—	—	CLKRCLK<3:0>				502
CLCxSELy	—	—	LCxDyS<5:0>						412
RxyPPS	—	—	—	RxyPPS<4:0>					242

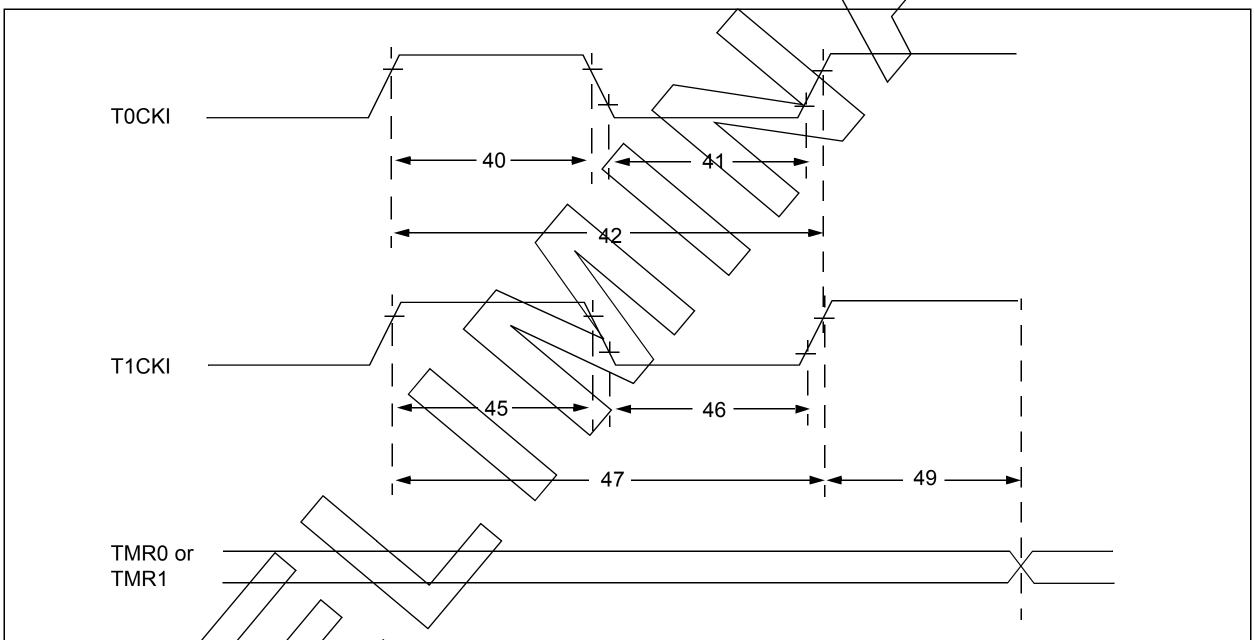
Legend: — = unimplemented, read as ‘0’. Shaded cells are not used by the CLKR module.

TABLE 37-17: ZERO CROSS DETECT (ZCD) SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristics**	**Min.**	**Typ†**	**Max.**	**Units**	**Comments**
ZC01	VPINZC	Voltage on Zero Cross Pin	—	0.75	—	V	
ZC02	IZCD_MAX	Maximum source or sink current	—	—	600	μA	
ZC03	TRESPH	Response Time, Rising Edge	—	1	—	μs	
	TRESPL	Response Time, Falling Edge	—	1	—	μs	

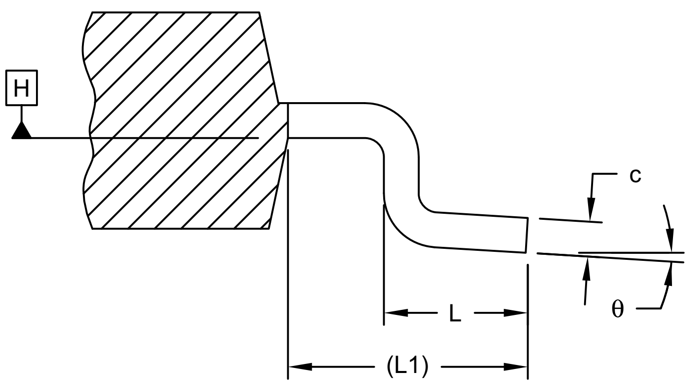
† Data in “Typ” column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 37-12: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

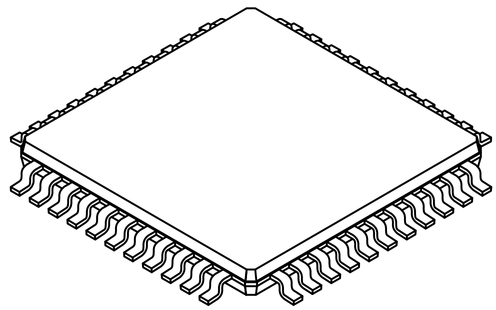


44-Lead Plastic Thin Quad Flatpack (PT) - 10x10x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



SECTION A-A



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		44	
Lead Pitch	e		0.80 BSC	
Overall Height	A	-	-	1.20
Standoff	A1	0.05	-	0.15
Molded Package Thickness	A2	0.95	1.00	1.05
Overall Width	E		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Width	b	0.30	0.37	0.45
Lead Thickness	c	0.09	-	0.20
Lead Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	θ	0°	3.5°	7°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Exact shape of each corner is optional.
3. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076C Sheet 2 of 2

APPENDIX A: DATA SHEET REVISION HISTORY

Revision A (12/2016)

Initial release of the document.